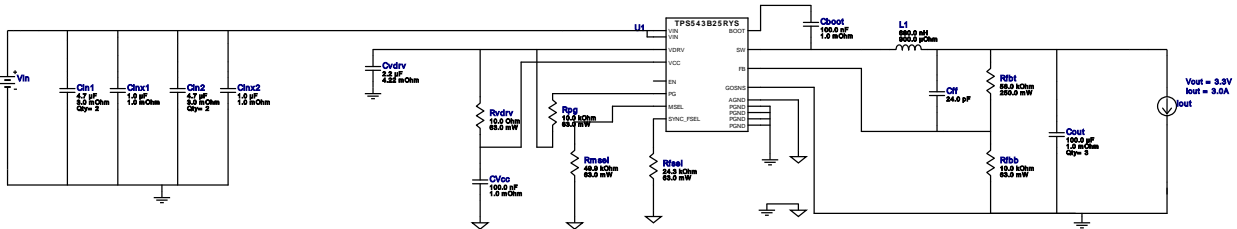


WEBENCH® Design Report








Design : 34 TPS543B25RYS
TPS543B25RYS 4V-12V to 1.00V @ 25A

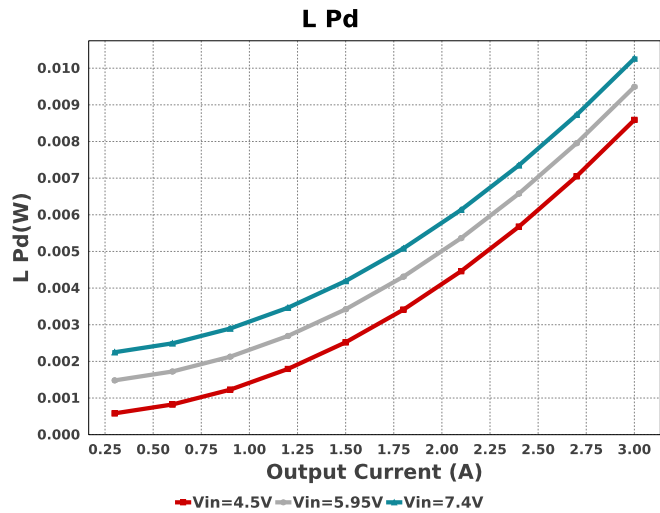
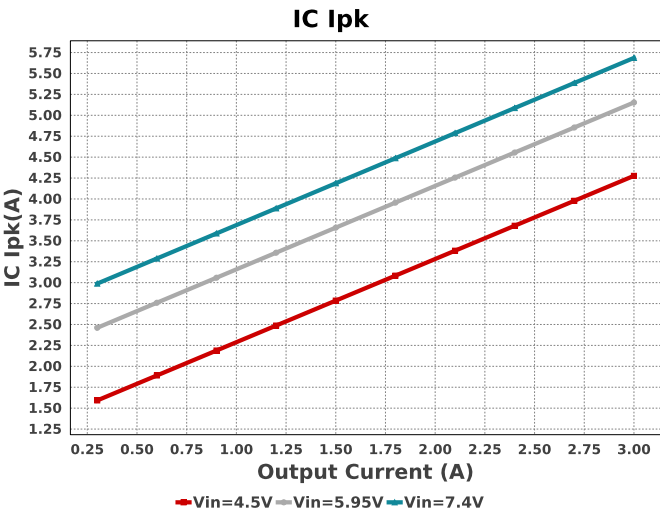
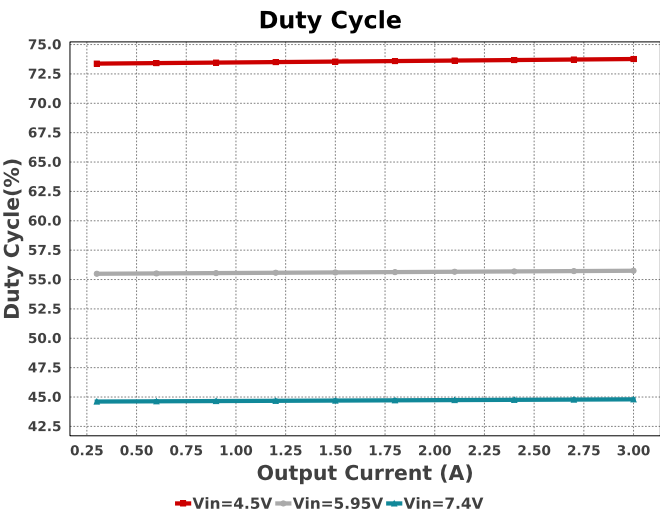
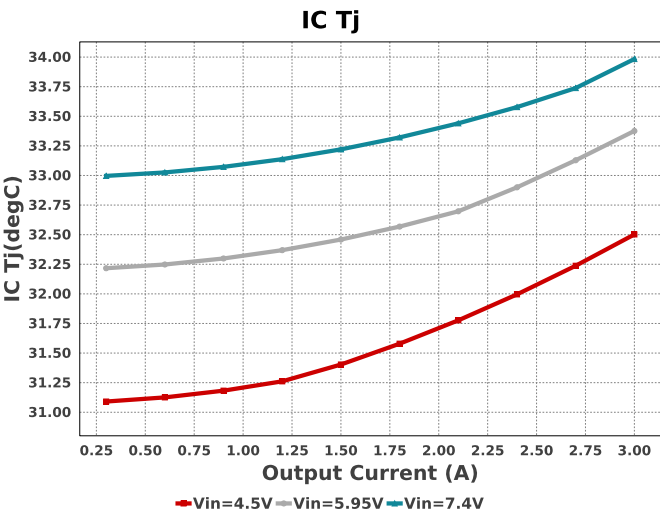


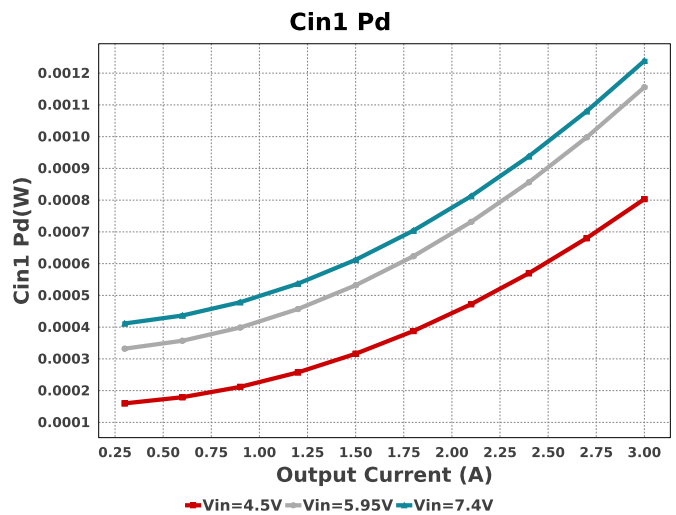
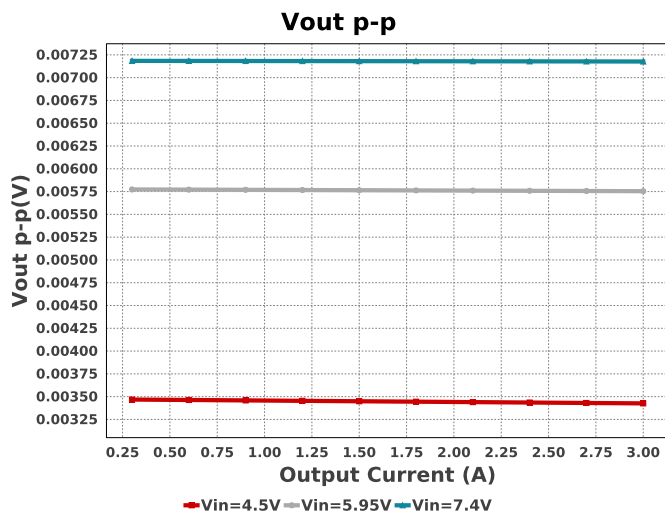
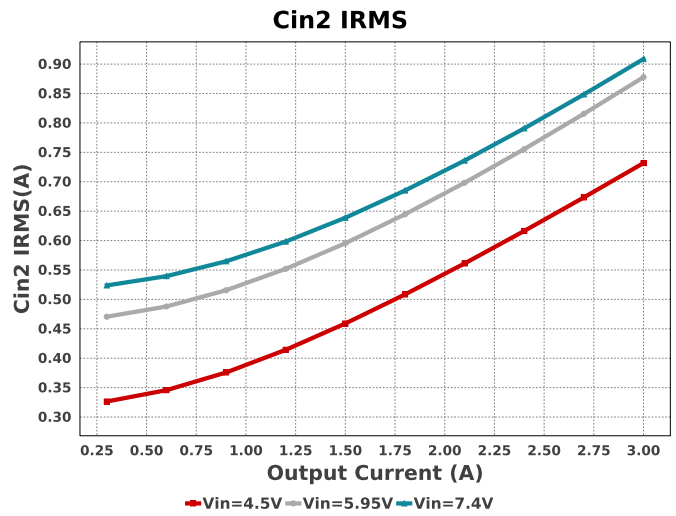
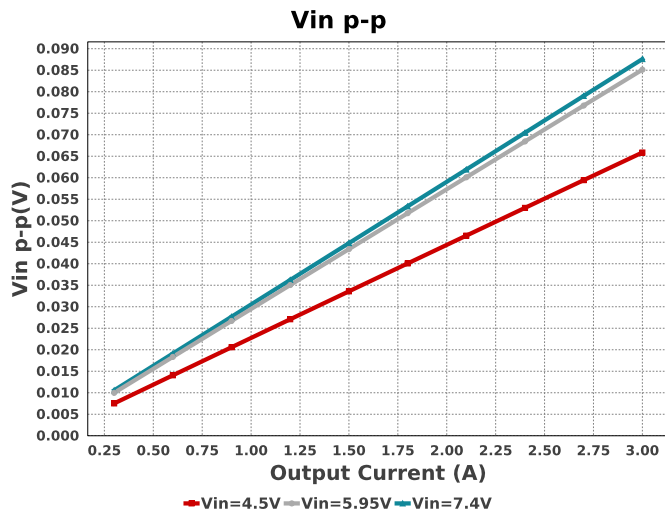
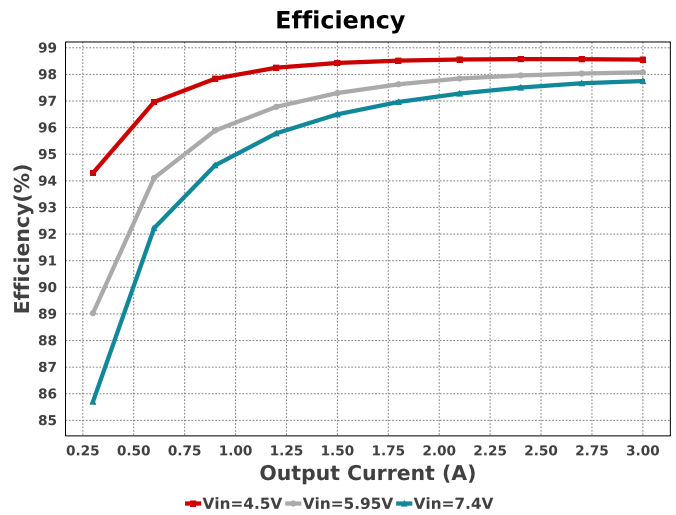
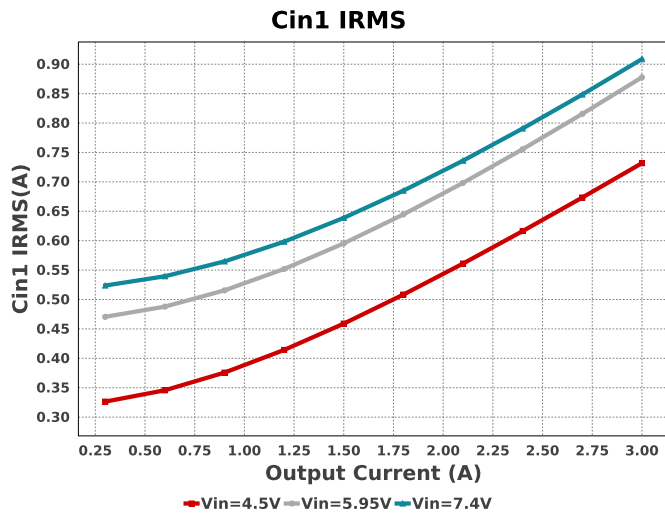
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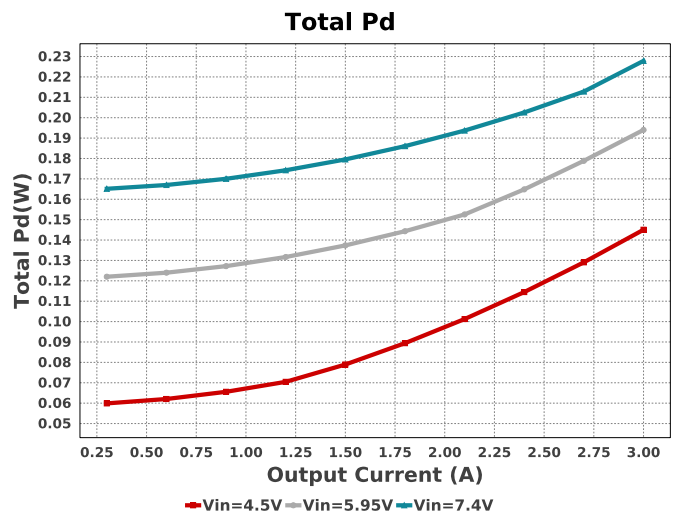
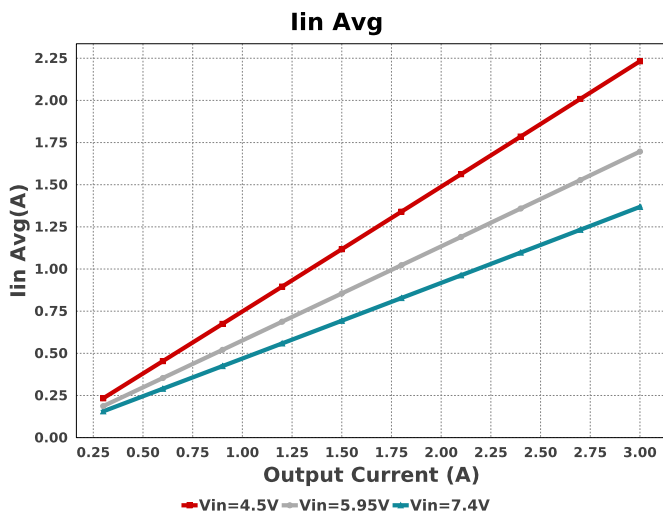
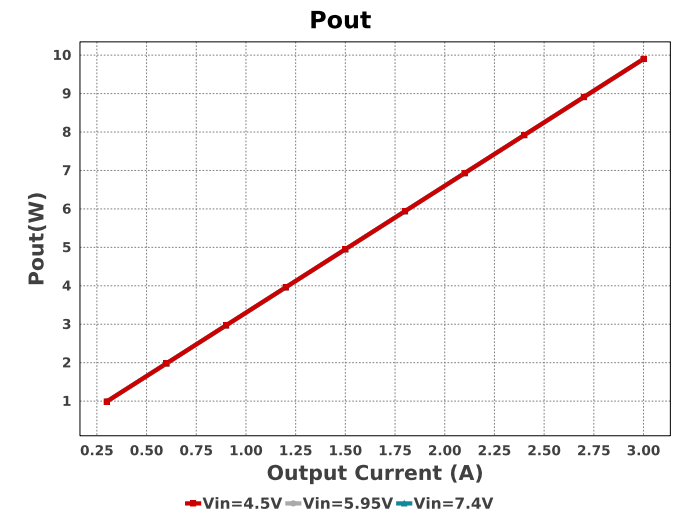
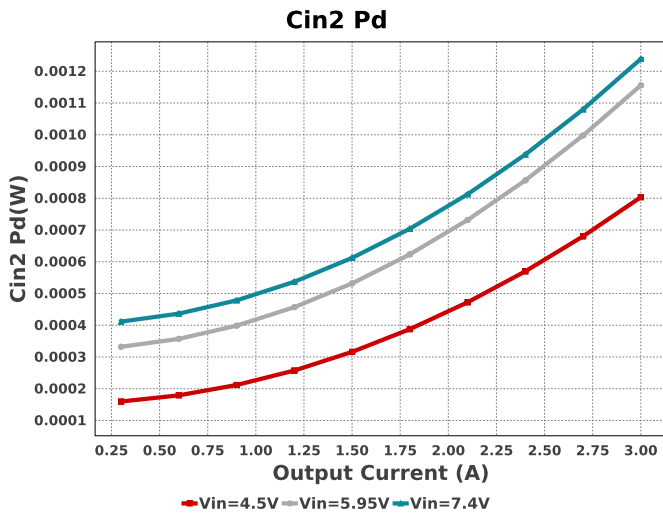
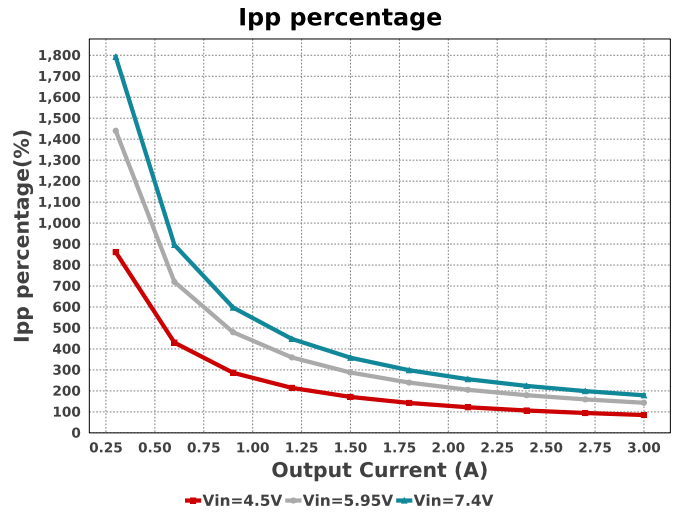
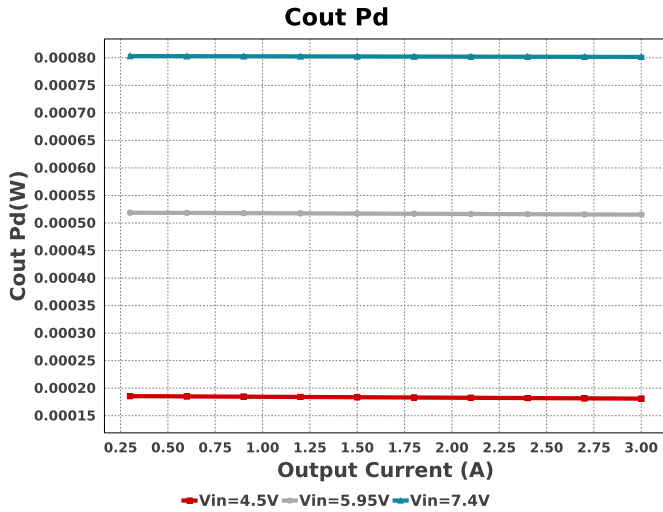
Electrical BOM

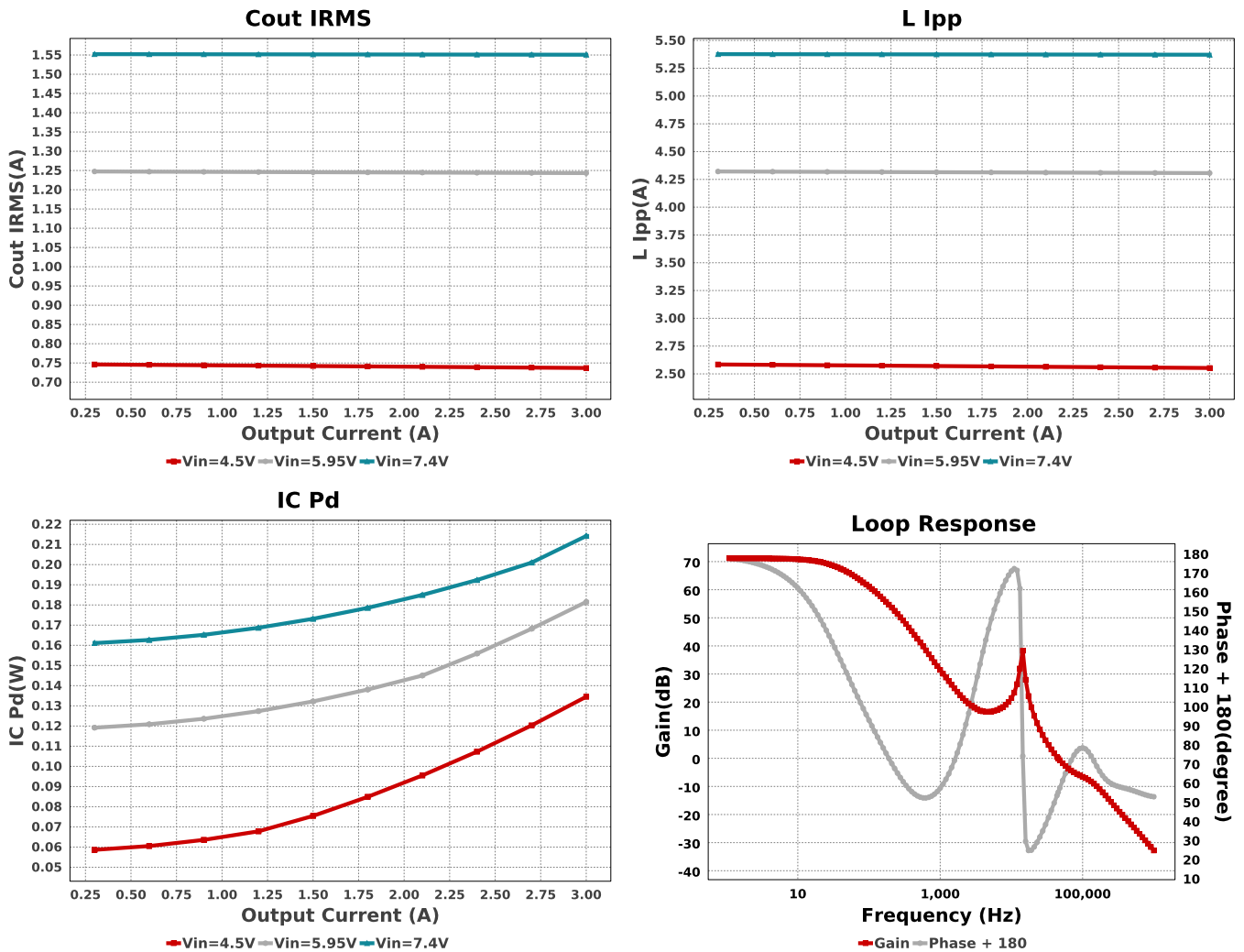
| Name | Manufacturer | Part Number | Properties | Qty | Price | Footprint |
|-------|--------------|-------------------------------------|---|-----|--------|---|
| CVcc | MuRata | GRM155R71A104KA01D Series= X7R | Cap= 100.0 nF ESR= 1.0 mOhm VDC= 10.0 V IRMS= 0.0 A | 1 | \$0.01 |  0402 3 mm ² |
| Cboot | MuRata | GRM155R71A104KA01D Series= X7R | Cap= 100.0 nF ESR= 1.0 mOhm VDC= 10.0 V IRMS= 0.0 A | 1 | \$0.01 |  0402 3 mm ² |
| Cff | Kemet | C0402C240J3GACTU Series= C0G/NP0 | Cap= 24.0 pF VDC= 25.0 V IRMS= 0.0 A | 1 | \$0.08 |  0402 3 mm ² |
| Cin1 | MuRata | GRM31CR71H475KA12L Series= X7R | Cap= 4.7 uF ESR= 3.0 mOhm VDC= 50.0 V IRMS= 4.98 A | 2 | \$0.10 |  1206 11 mm ² |
| Cin2 | MuRata | GRM31CR71H475KA12L Series= X7R | Cap= 4.7 uF ESR= 3.0 mOhm VDC= 50.0 V IRMS= 4.98 A | 2 | \$0.10 |  1206 11 mm ² |
| Cinx1 | Taiyo Yuden | EMK107B7105KA-T Series= X7R | Cap= 1.0 uF ESR= 1.0 mOhm VDC= 16.0 V IRMS= 0.0 A | 1 | \$0.01 |  0603 5 mm ² |
| Cinx2 | Taiyo Yuden | EMK107B7105KA-T Series= X7R | Cap= 1.0 uF ESR= 1.0 mOhm VDC= 16.0 V IRMS= 0.0 A | 1 | \$0.01 |  0603 5 mm ² |
| Cout | MuRata | GRM32EC80J107ME20L Series= X6S | Cap= 100.0 uF ESR= 1.0 mOhm VDC= 6.3 V IRMS= 6.0 A | 3 | \$0.17 |  1210_270 15 mm ² |
| Cvdrv | MuRata | GRM21BR71A225KA01L Series= X7R | Cap= 2.2 uF ESR= 4.22 mOhm VDC= 10.0 V IRMS= 2.08454 A | 1 | \$0.03 |  0805 7 mm ² |
| L1 | Coilcraft | XAL1010-681MEB | L= 680.0 nH 900.0 uOhm | 1 | \$1.71 |  XAL1010 160 mm ² |

| Name | Manufacturer | Part Number | Properties | Qty | Price | Footprint |
|-------|-------------------|--------------------------------------|--|-----|--------|---|
| Rfbb | Vishay-Dale | CRCW040210K0FKED Series= CRCW..e3 | Res= 10.0 kOhm Power= 63.0 mW Tolerance= 1.0% | 1 | \$0.01 |  0402 3 mm² |
| Rfbt | Yageo | RC1206FR-0756KL Series= ? | Res= 56.0 kOhm Power= 250.0 mW Tolerance= 1.0% | 1 | \$0.01 |  1206 11 mm² |
| Rfsel | Vishay-Dale | CRCW040224K3FKED Series= CRCW..e3 | Res= 24.3 kOhm Power= 63.0 mW Tolerance= 1.0% | 1 | \$0.01 |  0402 3 mm² |
| Rmsel | Vishay-Dale | CRCW040249K9FKED Series= CRCW..e3 | Res= 49.9 kOhm Power= 63.0 mW Tolerance= 1.0% | 1 | \$0.01 |  0402 3 mm² |
| Rpg | Vishay-Dale | CRCW040210K0FKED Series= CRCW..e3 | Res= 10.0 kOhm Power= 63.0 mW Tolerance= 1.0% | 1 | \$0.01 |  0402 3 mm² |
| Rvdrv | Vishay-Dale | CRCW040210R0FKED Series= CRCW..e3 | Res= 10.0 Ohm Power= 63.0 mW Tolerance= 1.0% | 1 | \$0.01 |  0402 3 mm² |
| U1 | Texas Instruments | TPS543B25RYS | Switcher | 1 | \$2.95 |  RYS0015A-MFG 19 mm² |









Operating Values

| # | Name | Value | Category | Description |
|-----|---------------------|-------------------|--------------------|---|
| 1. | Cin1 IRMS | 908.72 mA | Capacitor | Input capacitor RMS ripple current |
| 2. | Cin1 Pd | 1.239 mW | Capacitor | Input capacitor power dissipation |
| 3. | Cin2 IRMS | 908.72 mA | Capacitor | Input capacitor RMS ripple current |
| 4. | Cin2 Pd | 1.239 mW | Capacitor | Input capacitor power dissipation |
| 5. | Cout IRMS | 1.551 A | Capacitor | Output capacitor RMS ripple current |
| 6. | Cout Pd | 801.59 μ W | Capacitor | Output capacitor power dissipation |
| 7. | Total Cin ESR | 1.5 mOhm | Capacitor | Cin Capacitor ESR |
| 8. | Total Cout ESR | 333.333 μ Ohm | Capacitor | Cout Capacitor ESR |
| 9. | Cramp | 2.0 pF | IC | Selected Cramp for setting Ramp amplitude |
| 10. | IC Ipk | 5.686 A | IC | Peak switch current in IC |
| 11. | IC Pd | 214.18 mW | IC | IC power dissipation |
| 12. | IC Tj | 33.984 degC | IC | IC junction temperature |
| 13. | IC Tolerance | 5.0 mV | IC | IC Feedback Tolerance |
| 14. | ICThetaJA Effective | 18.6 degC/W | IC | Effective IC Junction-to-Ambient Thermal Resistance |
| 15. | Iin Avg | 1.369 A | IC | Average input current |
| 16. | Ipp percentage | 179.063 % | Inductor | Inductor ripple current percentage (with respect to average inductor current) |
| 17. | L Ipp | 5.372 A | Inductor | Peak-to-peak inductor ripple current |
| 18. | L Pd | 10.264 mW | Inductor | Inductor power dissipation |
| 19. | L1 DCR | 900.0 μ Ohm | Inductor | L1 DCR |
| 20. | Cin1 Pd | 1.239 mW | Power | Input capacitor power dissipation |
| 21. | Cin2 Pd | 1.239 mW | Power | Input capacitor power dissipation |
| 22. | Cout Pd | 801.59 μ W | Power | Output capacitor power dissipation |
| 23. | IC Pd | 214.18 mW | Power | IC power dissipation |
| 24. | L Pd | 10.264 mW | Power | Inductor power dissipation |
| 25. | Total Pd | 227.872 mW | Power | Total Power Dissipation |
| 26. | BOM Count | 21 | System Information | Total Design BOM count |
| 27. | Cross Freq | 45.429 kHz | System Information | Bode plot crossover frequency |
| 28. | Duty Cycle | 44.803 % | System Information | Duty cycle |

| # | Name | Value | Category | Description |
|-----|---|-----------------------|--------------------|--|
| 29. | Efficiency | 97.75 % | System Information | Steady state efficiency |
| 30. | FootPrint | 318.0 mm ² | System Information | Total Foot Print Area of BOM components |
| 31. | Frequency | 500.0 kHz | System Information | Switching frequency |
| 32. | Gain Marg | -65.822 dB | System Information | Bode Plot Gain Margin |
| 33. | Inductor ripple current requirement used for Inductor selection | 30.0 % | System Information | Custom Inductor ripple current (% of average inductor current) requirement used for Inductor selection |
| 34. | Iout | 3.0 A | System Information | Iout operating point |
| 35. | Iout transient step used for Cout calculations | 750.0 mA | System Information | Custom Transient current step requirement that was used for Cout selection (A). |
| 36. | Low Freq Gain | 71.175 dB | System Information | Gain at 1Hz |
| 37. | Mode | CCM | System Information | Conduction Mode |
| 38. | Overshoot Value | 304.77 μ V | System Information | Theoretical Vout Overshoot Value |
| 39. | Peak Over current Limit HS FET(Maximum) | 30.45 A | System Information | Over current protection threshold |
| 40. | Peak Over current Limit HS FET(Minimum) | 27.55 A | System Information | Over current protection threshold |
| 41. | Peak Over current Limit HS FET(typical) | 29.0 A | System Information | Over current protection threshold |
| 42. | Phase Marg | 55.573 deg | System Information | Bode Plot Phase Margin |
| 43. | Pout | 9.9 W | System Information | Total output power |
| 44. | Total BOM | \$5.78 | System Information | Total BOM Cost |
| 45. | Undershoot Value | 4.616 mV | System Information | Theoretical Vout Undershoot Value |
| 46. | Vin | 7.4 V | System Information | Vin operating point |
| 47. | Vin Ripple requirement used for Cin calculations | 5.0 % | System Information | Custom maximum input ripple requirement that was used for Cin selection(% of Minimum Vin). |
| 48. | Vin p-p | 87.591 mV | System Information | Peak-to-peak input voltage |
| 49. | Vout Actual | 3.3 V | System Information | Vout Actual calculated based on selected voltage divider resistors |
| 50. | Vout Ripple requirement used for Cout calculations | 1.0 % | System Information | Custom maximum output ripple requirement that was used for Cout selection(% of Vout). |
| 51. | Vout Tolerance | 2.731 % | System Information | Vout Tolerance based on IC Tolerance (no load) and voltage divider resistors if applicable |
| 52. | Vout p-p | 7.177 mV | System Information | Peak-to-peak output ripple voltage |
| 53. | Vout transient requirement used for Cout calculations | 4.0 % | System Information | Custom Transient voltage change requirement that was used for Cout selection (% of Vout). |

Design Inputs

| Name | Value | Description |
|---------|-----------|-----------------------------|
| Iout | 3.0 | Maximum Output Current |
| VinMax | 7.4 | Maximum input voltage |
| VinMin | 4.5 | Minimum input voltage |
| Vout | 3.3 | Output Voltage |
| base_pn | TPS543B25 | Base Product Number |
| source | DC | Input Source Type |
| Ta | 30.0 | Ambient temperature |
| UserFsw | 500.0 | Customer Selected Frequency |

WEBENCH® Assembly

Component Testing

Some published data on components in datasheets such as Capacitor ESR and Inductor DC resistance is based on conservative values that will guarantee that the components always exceed the specification. For design purposes it is usually better to work with typical values. Since this data is not always available it is a good practice to measure the Capacitance and ESR values of C_{in} and C_{out} , and the inductance and DC resistance of $L1$ before assembly of the board. Any large discrepancies in values should be electrically simulated in WEBENCH to check for instabilities and thermally simulated in WebTHERM to make sure critical temperatures are not exceeded.

Soldering Component to Board

If board assembly is done in house it is best to tack down one terminal of a component on the board then solder the other terminal. For surface mount parts with large tabs, such as the DPAK, the tab on the back of the package should be pre-tinned with solder, then tacked into place by one of the pins. To solder the tab down to the board place the iron down on the board while resting against the tab, heating both surfaces simultaneously. Apply light pressure to the top of the plastic case until the solder flows around the part and the part is flush with the PCB. If the solder is not flowing around the board you may need a higher wattage iron (generally 25W to 30W is enough).

Initial Startup of Circuit

It is best to initially power up the board by setting the input supply voltage to the lowest operating input voltage 4.5V and set the input supply's current limit to zero. With the input supply off connect up the input supply to V_{in} and GND. Connect a digital volt meter and a load if needed to set the minimum load of the design from V_{out} and GND. Turn on the input supply and slowly turn up the current limit on the input supply. If the voltage starts to rise on the input supply continue increasing the input supply current limit while watching the output voltage. If the current increases on the input supply, but the voltage remains near zero, then there may be a short or a component misplaced on the board. Power down the board and visually inspect for solder bridges and recheck the diode and capacitor polarities. Once the power supply circuit is operational then more extensive testing may include full load testing, transient load and line tests to compare with simulation results.

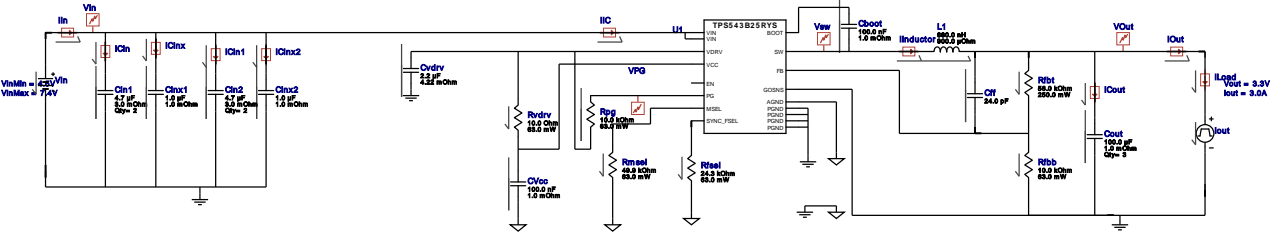
Load Testing

The setup is the same as the initial startup, except that an additional digital voltmeter is connected between V_{in} and GND, a load is connected between V_{out} and GND and a current meter is connected in series between V_{out} and the load. The load must be able to handle at least rated output power + 50% (7.5 watts for this design). Ideally the load is supplied in the form of a variable load test unit. It can also be done in the form of suitably large power resistors. When using an oscilloscope to measure waveforms on the prototype board, the ground leads of the oscilloscope probes should be as short as possible and the area of the loop formed by the ground lead should be kept to a minimum. This will help reduce ground lead inductance and eliminate EMI noise that is not actually present in the circuit.



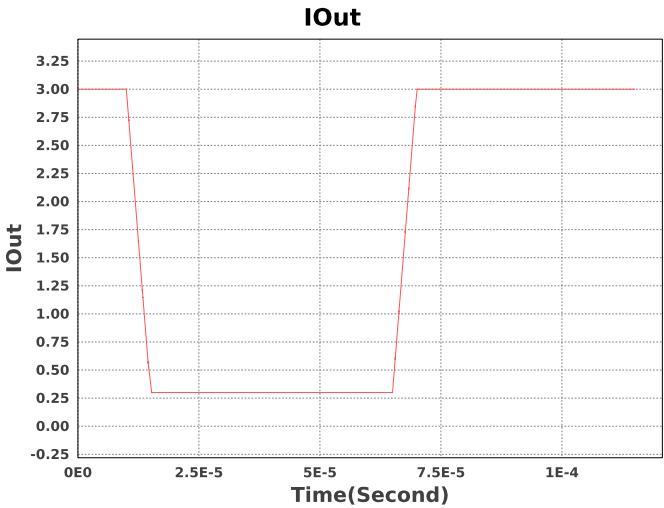
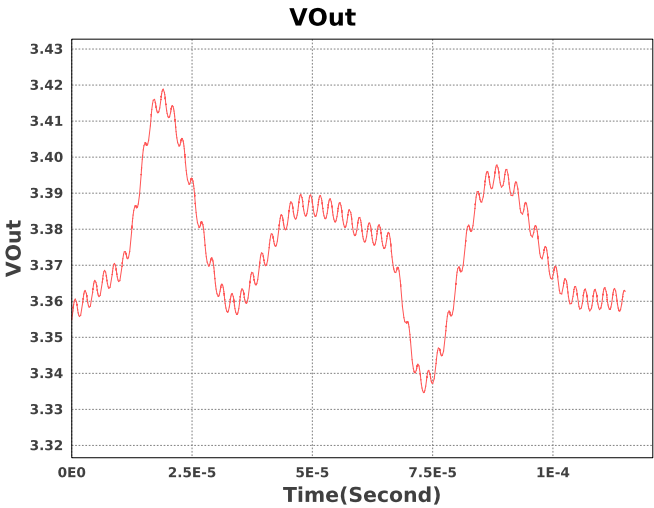
WEBENCH® Electrical Simulation Report

Design Id = 34
sim_id = 1
Simulation Type = Load Transient



Simulation Parameters

| # | Name | Parameter Name | Description | Values |
|----|------|----------------|--------------------|---------|
| 1. | Cin1 | IC | inputvoltage | 5.95 |
| 2. | L1 | IC | no description | 3.0 |
| 3. | Cin2 | IC | no description | 5.95 |
| 4. | Cin1 | IC | no description | 5.95 |
| 5. | Cout | IC | no description | 3.3 |
| 6. | Cin2 | IC | no description | 5.95 |
| 7. | Iout | signal_type | Signal Type | PULSE |
| | | I1 | Initial Current | 3.0 A |
| | | I2 | Peak Current | 0.3 A |
| | | Td | Initial Delay Time | 10u Sec |
| | | Tf | Fall Time | 5u Sec |
| | | Tr | Rise Time | 5u Sec |
| | | Pw | Pulse Width | 50u Sec |



Design Assistance

- Master key : 27AFC3A06A218B6F8EA41ED3B4C0DDB7[v1]
- TPS543B25 Product Folder : <http://www.ti.com/product/TPS543B25> : contains the data sheet and other resources.

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